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DATA SHEET

Solid State Relay OCMOS FET

# PS7141E-2A,PS7141EL-2A

### 8-PIN DIP, 400 V BREAK DOWN VOLTAGE NORMALLY OPEN TYPE 2-ch Optical Coupled MOS FET

-NEPOC Series-

#### DESCRIPTION

The PS7141E-2A and PS7141EL-2A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity. The PS7141EL-2A has a surface mount type lead.

#### FEATURES

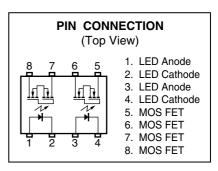
- 2 channel type (1 a + 1 a output)
- Low LED operating current (IF = 5 mA)
- Designed for AC/DC switching line changer
- Small package (8-pin DIP)
- Low offset voltage
- Ordering number of taping product: PS7141EL-2A-E3, E4
- Pb-Free product
- Safety standards

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- UL approved: File No. E72422
- BSI awaiting approval

#### **APPLICATIONS**

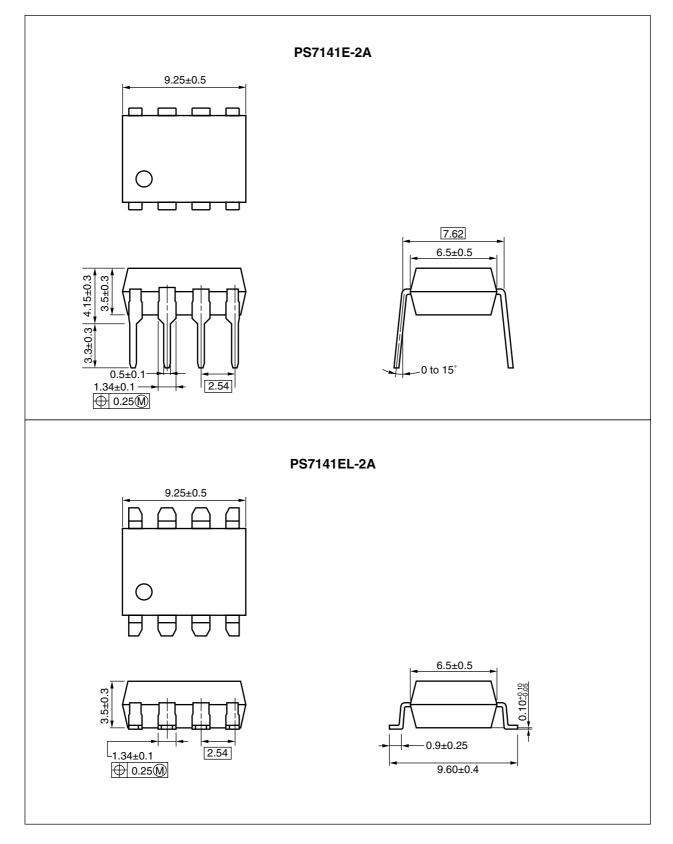
- Exchange equipment
- Measurement equipment
- FA/OA equipment



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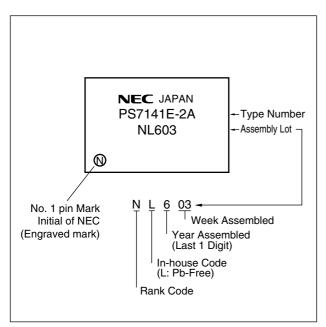


#### PACKAGE DIMENSIONS (in millimeters)





#### MARKING EXAMPLE





<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>1</sup>
PS7141E-2A	PS7141E-2A-A	Pb-Free	Magazine case 50 pcs	Standard products	PS7141E-2A
PS7141EL-2A	PS7141EL-2A-A			(UL approved)	
PS7141EL-2A-E3	PS7141EL-2A-E3-A		Embossed Tape 1 000 pcs/reel	BSI awaiting	
PS7141EL-2A-E4	PS7141EL-2A-E4-A			approval	

\*1 For the application of the Safety Standard, following part number should be used.

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lf	50	mA/ch
	Reverse Voltage	VR	5.0	V
	Power Dissipation	PD	50	mW/ch
	Peak Forward Current <sup>*1</sup>	IFP	1	A/ch
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	lı.	100	mA/ch
	Pulse Load Current <sup>*2</sup> (AC/DC Connection)	Ilp	200	mA/ch
	Power Dissipation	Po	375	mW/ch
Isolation Voltage <sup>3</sup>		BV	1 500	Vr.m.s.
Total Power Dissipation		Ρτ	850	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-40 to +100	°C

\*1 PW = 100 *µ*s, Duty Cycle = 1%

\*2 PW = 100 ms, 1 shot

\*3 AC voltage for 1 minute at  $T_A = 25^{\circ}C$ , RH = 60% between input and output Pins 1-4 shorted together, 5-8 shorted together.

#### **RECOMMENDED OPERATING CONDITIONS (TA = 25°C)**

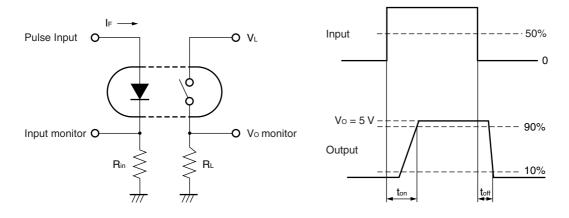
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	5	10	20	mA
LED Off Voltage	VF	0		0.5	V



#### ELECTRICAL CHARACTERISTICS (TA = 25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	IR	V <sub>R</sub> = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 400 V		0.01	1.0	μA
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		36		pF/ch
Coupled	LED On-state Current	IFon	I∟ = 100 mA			5.0	mA
	On-state Resistance	Ron1	I⊧ = 10 mA, I∟ = 10 mA		36	50	Ω
		Ron2	$I_{\text{F}}$ = 10 mA, $I_{\text{L}}$ = 100 mA, $t \leq$ 10 ms		25	35	
	Turn-on Time <sup>*1, 2</sup>	ton	IF = 10 mA, Vo = 5 V, RL = 500 Ω,		0.4	1.0	ms
	Turn-off Time *1, 2	toff	PW ≥ 10 ms		0.07	0.2	
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 <sup>9</sup>			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1 MHz		1.1		pF/ch

\*1 Test Circuit for Switching Time



\*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
 Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE

300

200

100

0

200

150

100

50

0

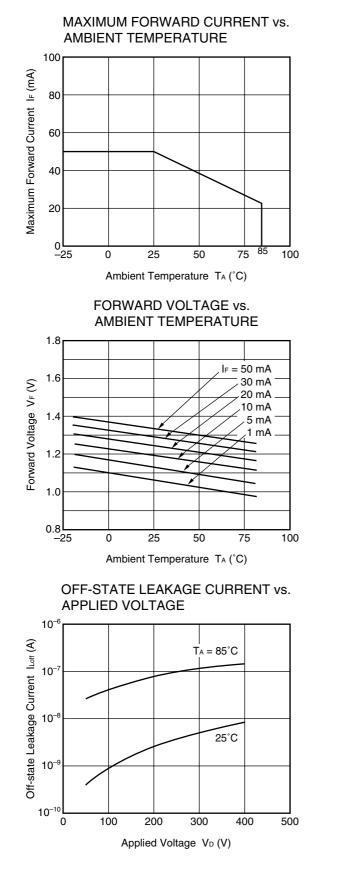
Output Capacitance Cout (pF)

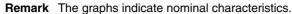
Load Current IL (mA)

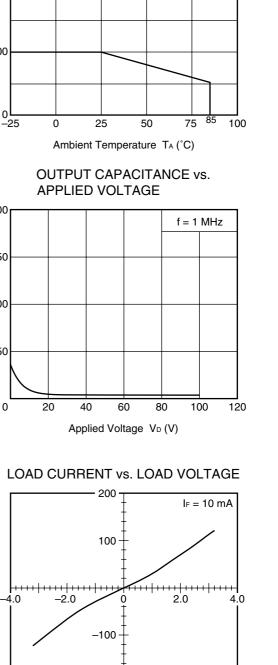
Maximum Load Current IL (mA)

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#### <R> TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C, unless otherwise specified)



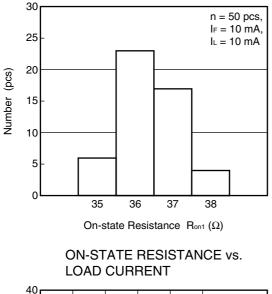


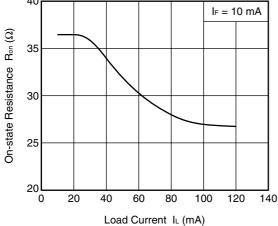


-200

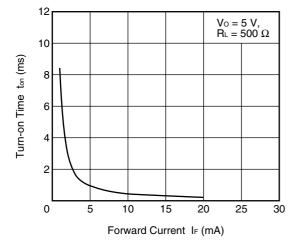


#### ON-STATE RESISTANCE DISTRIBUTION

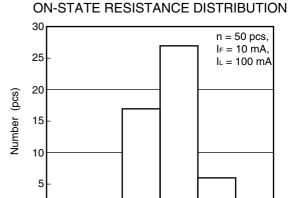




TURN-ON TIME vs. FORWARD CURRENT



Remark The graphs indicate nominal characteristics.



On-state Resistance  $R_{on2}(\Omega)$ 

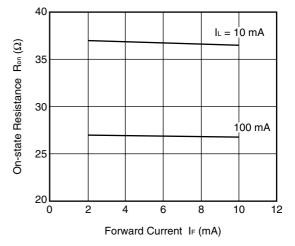
25

26

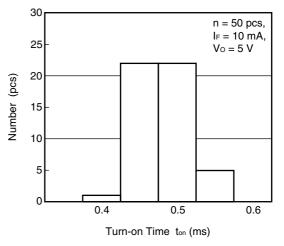
24

0



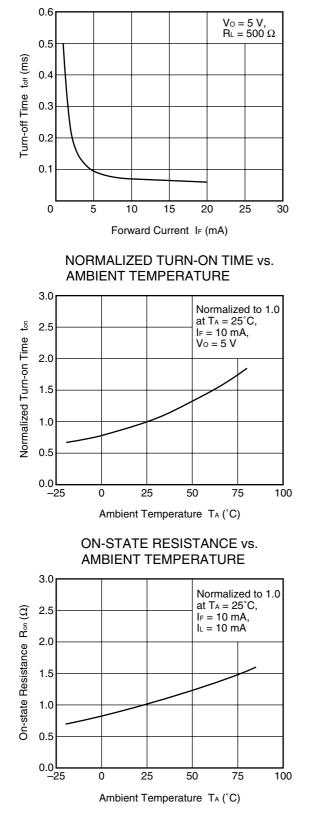


#### TURN-ON TIME DISTRIBUTION



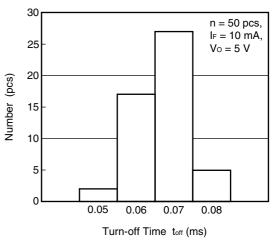


#### TURN-OFF TIME vs. FORWARD CURRENT

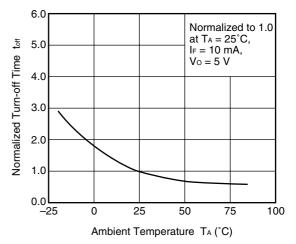


Remark The graphs indicate nominal characteristics.

#### TURN-OFF TIME DISTRIBUTION

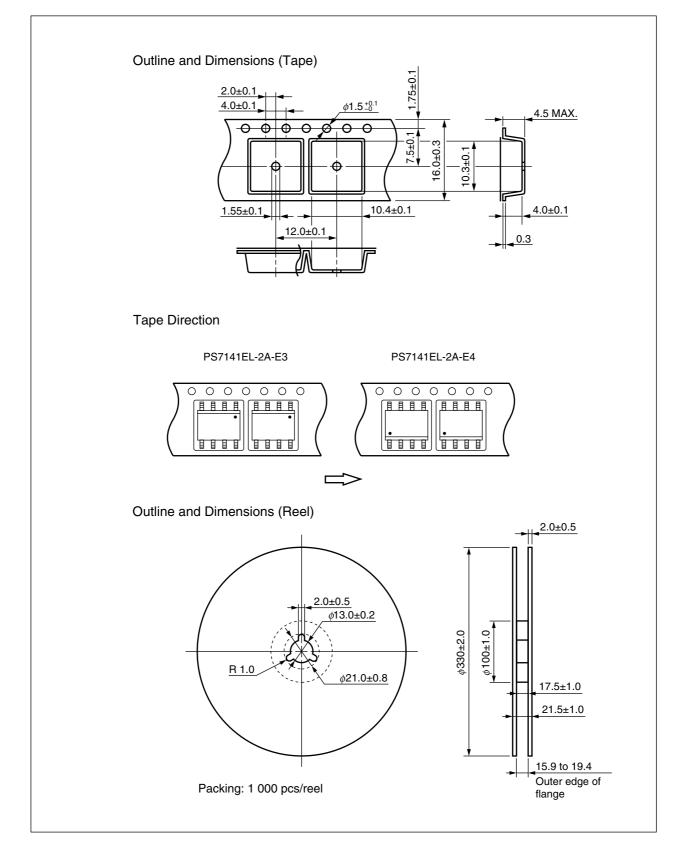


## NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE





#### **TAPING SPECIFICATIONS (in millimeters)**





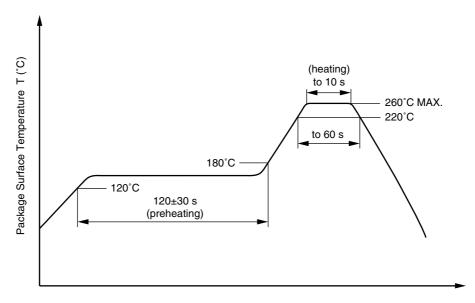
#### **RECOMMENDED SOLDERING CONDITIONS**

#### (1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

<ul> <li>Temperature</li> </ul>	260°C or below (molten solder temperature)
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- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
   One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### <R> (3) Soldering by soldering iron

<ul> <li>Peak temperature (lead part temperature)</li> </ul>	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)
• Time (each pins)	Rosin flux containing small amount of chlorine (The flux with a

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over  $100^{\circ}C$ .

#### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.



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#### <R> USAGE CAUTIONS

- **1.** Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



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	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	<ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol>
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	<ul> <li>Do not lick the product or in any way allow it to enter the mouth.</li> </ul>

► For further information, please contact

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